SCAS115 - D3458, MARCH 1990 - REVISED APRIL 1993

- Inputs Are TTL-Voltage Compatible
- Independent Registers A and B Buses
- Multiplexed Real-Time and Stored Data
- Inverting Data Paths
- Flow-Through Architecture to Optimize PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C

description

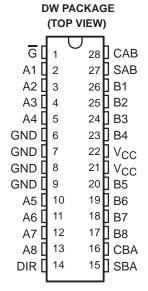
The 74ACT11648 consists of bus transceiver circuits with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from

the internal storage registers. Data on the A or B bus will be clocked into the registers on the low-to-high transition of the appropriate clock pin (CAB or CBA). Examples of the four fundamental bus-management functions that can be performed with the octal bus transceivers and registers are shown in Figure 1.

Enable (\overline{G}) and direction (DIR) pins are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select controls (SAB and SBA) can multiplex stored and real-time (transparent mode) data. The circuitry used for select control will eliminate the typical decoding glitch that occurs in a mulitplexer during the transition between stored and real-time data. The direction control determines which bus will receive data when enable \overline{G} is active (low). In the isolation mode (control \overline{G} high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The 74ACT11648 is characterized for operation from – 40°C to 85°C.



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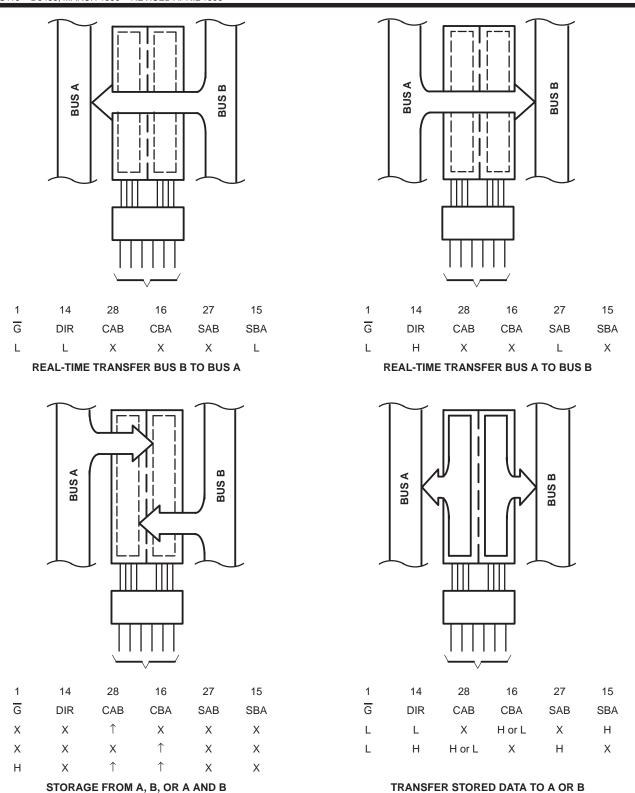


Figure 1. Bus-Management Functions



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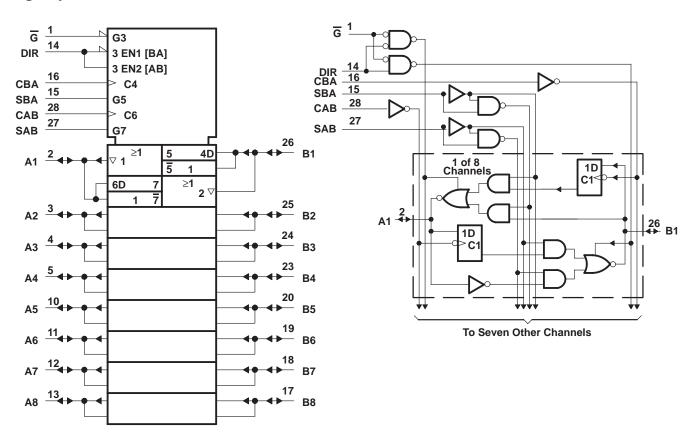
FUNCTION TABLE

		INF	PUTS			DAT	A I/O	ODERATION OR FUNCTION
G	DIR	CAB	СВА	SAB	SBA	A1 THRU A8	B1 THRU B8	OPERATION OR FUNCTION
Х	Х	↑	Х	Х	Χ	Input	Unspecified [†]	Store A, B unspecified [†]
Х	Χ	X	\uparrow	Χ	Χ	Unspecified [†]	Input	Store B, A unspecified [†]
Н	Χ	\uparrow	\uparrow	X	Χ	Input	Input	Store A and B Data
Н	Χ	H or L	H or L	X	Χ	Input	Input	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-Time B Data to A Bus
L	L	X	H or L	X	Н	Output	Input	Stored B Data to A Bus
L	Н	X	X	L	Χ	Input	Output	Real-Time A Data to B Bus
L	Н	H or L	X	Н	Χ	Input	Output	Stored A Data to B Bus

[†] The data output functions may be enabled or disabled by various signals at the \overline{G} and DIR inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low-to-high transition on the clock inputs.

logic symbol‡

logic diagram (positive logic)



[‡] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	$\ldots \ldots -0.5$ V to 7 V
Input voltage range, V _I (see Note 1)	\dots – 0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	$\dots \dots \pm 50 \text{ mA}$
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	$\dots \dots \pm 50 \text{ mA}$
Continuous current through V _{CC} or GND	$\dots \dots \pm 200 \text{ mA}$
Storage temperature range	– 65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			8.0	V
٧ı	Input voltage	0		VCC	V
VO	Output voltage	0		VCC	V
lOH	High-level output current			-24	mA
lOL	Low-level output current			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	ns/V
TA	Operating free-air temperature	-40		85	°C



NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEGT CONDITIONS	V	T _A = 25°C				MAY	LINUT
		TEST CONDITIONS	vcc	MIN	TYP	MAX	MIN	MAX	UNIT
		Jan. 50 vA	4.5 V	4.4			4.4		
		ΙΟΗ = - 50 μΑ	5.5 V	5.4			5.4		
Vон		Jan. 24 mA	4.5 V	3.94			3.8		V
		I _{OH} = - 24 mA	5.5 V	4.94			4.8		
		$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
		- FO A	4.5 V			0.1		0.1	V
		I _{OL} = 50 μA	5.5 V			0.1		0.1	
VOL		I. 24 mA	4.5 V			0.36		0.44	
		I _{OL} = 24 mA	5.5 V			0.36		0.44	
		$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
Ц	Control Inputs	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		± 1	μΑ
loz	A or B ports‡	$V_I = V_{CC}$ or GND	5.5 V			± 0.5		± 5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ
Δl _{CC} §		One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1	mA
Ci	Control Inputs	$V_I = V_{CC}$ or GND	5 V		4.5				pF
Cio	A or B ports	$V_I = V_{CC}$ or GND	5 V		12			·	þг

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended range of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

		$T_A = 2$	25°C	BAINI	MAV	LINUT
		MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency	0	90	0	75	MHz
t _W	Pulse duration, CAB or CBA high or low	6.7		6.7		ns
t _{su}	Setup time, A before CAB↑ or B before CBA↑	5		5		ns
t _h	Hold time, A after CAB↑ or B after CBA↑	2		2	·	ns

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

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switching characteristics over recommended ranges of supply voltage operating free-air temperature (unless otherwise noted) (see Figure 2)

	FROM	то	T,	4 = 25°C	;	MIN MA		
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX		WAX	UNIT
f _{max}			75			75		MHz
t _{PLH}	A or D	D or A	2.4	6.5	9.5	2.4	10.7	20
^t PHL	A or B	B or A	4.4	8.5	11.3	4.4	12.7	ns
^t PZH	G	A D	4.2	9.2	13	4.2	14.6	
t _{PZL}	G	A or B	4.3	9.8	13.9	4.3	15.6	ns
^t PHZ	ĪG	A D	5.7	8.7	11.3	5.7	12.2	
tPLZ	G	A or B	5.3	8.1	10.5	5.3	11.4	ns
^t PLH	ODA == 0AB	A or B	5.2	9.4	12	5.2	13.7	
^t PHL	CBA or CAB		6	10.5	13.5	6	15.2	ns
^t PLH	SAB or SBA [†]	A or B	4.7	8.6	11.3	4.7	12.9	
^t PHL	(with A or B high)		3.8	8.6	12	3.8	13.4	ns
t _{PLH}	SBA or SAB [†]		2.6	7.1	10.2	2.6	11.5	
t _{PHL}	(with A or B low)	A or B	5.4	9.7	12.6	5.4	14.1	ns
^t PZH	0.0		3.9	9.8	14.9	3.9	16.9	
t _{PZL}	DIR	A or B	3.9	10.8	15.1	3.9	17.2	ns
t _{PHZ}	DIR	A or B	4.5	8.2	10.6	4.5	11.5	200
t _{PLZ}	אוט	AUIB	3.9	7.3	9.6	3.9	11.3	ns

[†] These parameters are measured with the internal output state of the storage register opposite to that of the bus input.

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CON	TYP	UNIT		
	Parameter and the state of the same of the	Outputs enabled	0 50 - 5	6 4 MIL	61	_
Cpd	Power dissipation capacitance per transceivers	Outputs disabled	$C_L = 50 pF$,	f = 1 MHz	15	pF

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S1

Open

 $2 \times V_{CC}$

GND

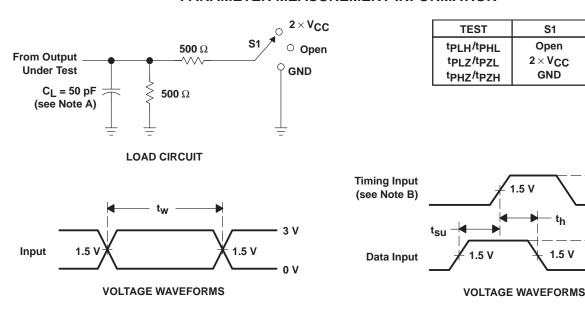
1.5 V

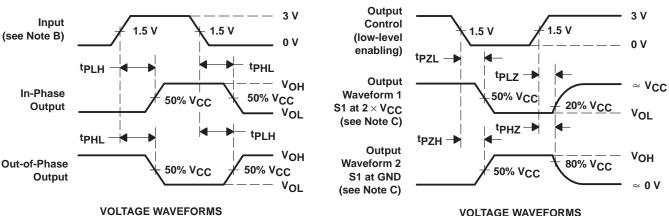
VOLTAGE WAVEFORMS

3 V

0 V

PARAMETER MEASUREMENT INFORMATION





NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50 \Omega$, $t_{f} = 3 \text{ ns}$, $t_{f} = 3 \text{ ns}$.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms





i.com 24-Jun-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ACT11648DW	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
74ACT11648DWR	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
74ACT11648DWR	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
74ACT11648NT	OBSOLETE	PDIP	NT	28	TBD	Call TI	Call TI
74ACT11648NT	OBSOLETE	PDIP	NT	28	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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		Wireless	www.ti.com/wireless-apps